REV LETTER: F PAGE NO: 1 OF 1 PART NUMBER:

## **Polymer PTC Devices**

Surface mount fuses

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# LP-NSM110 **Features**

- Small size of 1206 Lead-free and compliant with the European Union RoHS Directive 2002/95/EC
- Fast tripping resettable circuit protection П
- Surface mount packaging for automated assembly
- Agency Recognition: UL, CSA П



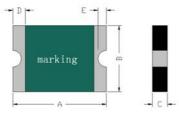


#### **Product Dimensions (mm)**

Dant number	Α	В	С	D	Е	— Part marking	
Part number —	Max.	Max.	Max.	Min.	Min.	- Fart marking	
LP-NSM110	3.50	1.80	1.30	0.10	0.20	0	

CAL IIS

E-mail: market@way-on.com



Top View

Side View

### **Electrical Characteristics**

Part number	Ι <sub>Η</sub>	Ι <sub>Τ</sub>	$V_{max}$	I <sub>max</sub>	T <sub>trij</sub>	0	Pd <sub>typ</sub>	R <sub>min</sub>	R <sub>1max</sub>
Part number -	(A)	(A)	(V)	(A)	Current(A)	Time(S)	(W)	(Ω)	(Ω)
LP-NSM110	1.10	1.80	6	40	8.0	0.30	0.6	0.055	0.21

I<sub>H</sub>=Hold current: maximum current at which the device will not trip at 25℃ still air.

I<sub>T</sub>=Trip current: minimum current at which the device will always trip at 25℃ still air.

V<sub>max</sub>=Maximum voltage device can withstand without damage at rated current.

I<sub>max</sub>=Maximum fault current device can withstand without damage at rated voltage.

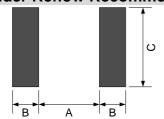
T<sub>trip</sub>=Maximum time to trip(s) at assigned current.

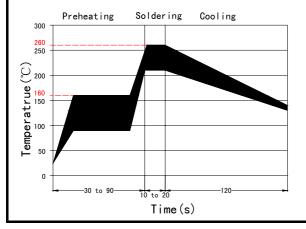
Pd<sub>tvo</sub>=Typical power dissipation: typical amount of power dissipated by the device when in state air environment.

R<sub>min</sub>=Minimum device resistance at 25℃ prior to tripping.

R<sub>1max</sub>=Maximum device resistance measured in the nontripped state 1 hour post reflow.

### Solder Reflow Recommendations





Solder Pad Layouts						
Part number	Α	В	С			
_	(mm)	(mm)	(mm)			
LP-NSM110	1.80	1.00	1.80			

- \* Recommended reflow methods: IR, Vapor phase, hot air oven.
- \* Devices can be cleaned using standard industry methods and solvents.

#### Notes:

- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.
- Devices are not designed to be wave soldered to the bottom side of the board.

#### **Package Information**

Tape & Reel: 4000pcs per reel.

Effectivity: Reference documents shall be the issue in effect on the date of invitation for bid.

Caution: Operation beyond the rated voltage or current may result in rupture electrical arcing or flame.